IPC ASSOCIATION ELECTRONIC	© Copyright 200	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				k	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
Supplie	r Information														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
onsemi												2025-05-13			
Contact N	Name	Title - Conta	Title - Contact			Phone - Contact*				Email - Contact*					
?roduct-l	Env-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*		Title - Representative			F	Phone - Representative*				Email - Representative*				
Product-	Env-Stewards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	tive Date Version Manufacturing Si		ring Site	V	/eight*	UOM	Unit Type	
		NTBG020N120SC1 SiC MC		SiC MOS D2PAK	iC MOS D2PAK-7L 20mohm 1200V		2025-05-13			СРА		1	576.704	mg	Each
Ianufa	acturing Process Inform							•							·
			The state of the s		-STD-020 MSL	Rating			s Body Temperature Max Time at Peak				er of Reflow Cyc	cles	
	Matte Tin (Sn) - annealed		CU Alloy	1			245		C	30		second	s 3		
omments															
	naximum time at peak tempe														
or more	information regarding mater	rial composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and/Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.29	mg	Supplier	Silicon Carbide	409-21-2		5.29	mg
Die Attach Solder	7.49	mg	Supplier	Silver (Ag)	7440-22-4		0.1873	mg
			A	Lead (Pb)	7439-92-1	7a	6.9282	mg
			Supplier	Tin (Sn)	7440-31-5		0.3745	mg
Lead Frame	921.0	mg	В	Nickel (Ni)	7440-02-0		9.21	mg
			Supplier	Copper (Cu)	7440-50-8		911.79	mg
Mold Compound-Black	626.0			Epoxy resin	proprietary data		18.78	mg
			Supplier	Phenolic Resin	Proprietary Data		9.39	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		93.9	mg
			Supplier	Carbon Black (C)	1333-86-4		3.13	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		500.8	mg
Plating	0.224	mg	Supplier	Tin (Sn)	7440-31-5		0.224	mg
Wire Bond - Al	16.7	mg	Supplier	Aluminum (Al)	7429-90-5		16.7	mg